

PATENT

Docket No.:JCLA10375-D

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Applicant : YU-LUNG YU et al.
Filed : Herewith
For : WAFER LEVEL TESTING AND BUMPING PROCESS

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Prior to the examination on merits, please amend the above-identified application as shown in the attached sheets. No new matter has added through the amendment. Entry of the amendment is requested.